

FEATURES

Fully differential

Extremely low power with power-down feature

2.6 mA quiescent supply current @ 5 V

450 μ A in power-down mode @ 5 V

High speed

110 MHz large signal 3 dB bandwidth @ $G = 1$

450 V/ μ s slew rate

12-bit SFDR performance @ 500 kHz

Fast settling time: 100 ns to 0.02%

Low input offset voltage: ± 2.6 mV max

Low input offset current: 0.45 μ A max

Differential input and output

Differential-to-differential or single-ended-to-differential operation

Rail-to-rail output

Adjustable output common-mode voltage

Externally adjustable gain

Wide supply voltage range: 2.7 V to 12 V

Available in small SOIC package

APPLICATIONS

12-bit ADC drivers

Portable instrumentation

Battery-powered applications

Single-ended-to-differential converters

Differential active filters

Video amplifiers

Level shifters

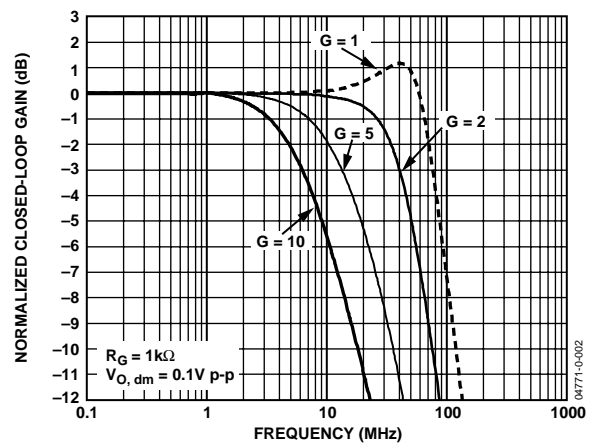
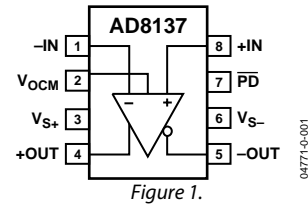
GENERAL DESCRIPTION

The AD8137 is a low cost differential driver with a rail-to-rail output that is ideal for driving 12-bit ADCs in systems that are sensitive to power and cost. The AD8137 is easy to apply, and its internal common-mode feedback architecture allows its output common-mode voltage to be controlled by the voltage applied to one pin. The internal feedback loop also provides inherently balanced outputs as well as suppression of even-order harmonic distortion products. Fully differential and single-ended-to-differential gain configurations are easily realized by the AD8137. External feedback networks consisting of four resistors determine the amplifier's closed-loop gain. The power-down feature is beneficial in critical low power applications.

Rev. B

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FUNCTIONAL BLOCK DIAGRAM



The AD8137 is manufactured on Analog Devices' proprietary second generation XFCB process, enabling it to achieve high levels of performance with very low power consumption.

The AD8137 is available in the small 8-lead SOIC package and 3 mm \times 3 mm LFCSP. It is rated to operate over the extended industrial temperature range of -40°C to $+125^{\circ}\text{C}$.

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REVISION HISTORY

7/05—Rev. A to Rev. B

Changes to Ordering Guide	24
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8/04—Rev. 0 to Rev. A.

Added 8-Lead LFCSP.....	Universal
Changes to Layout	Universal
Changes to Product Title	1
Changes to Figure 1	1
Changes to Specifications	3
Changes to Absolute Maximum Ratings	6
Changes to Figure 4 and Figure 5.....	7
Added Figure 6, Figure 20, Figure 23, Figure 35, Figure 48, and Figure 58; Renumbered Successive Figures	7
Changes to Figure 32.....	12
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Changes to Figure 64 and Figure 65.....	20
Changes to Figure 66.....	22
Added Driving an ADC with Greater Than 12-Bit Performance Section	22
Changes to Ordering Guide	24
Updated Outline Dimensions	24

5/04—Revision 0: Initial Version

SPECIFICATIONS

$V_S = \pm 5\text{ V}$, $V_{OCM} = 0\text{ V}$ (@ 25°C, differential gain = 1, $R_{L, dm} = R_F = R_G = 1\text{ k}\Omega$, unless otherwise noted, T_{MIN} to $T_{MAX} = -40^\circ\text{C}$ to $+125^\circ\text{C}$).

Table 1.

Parameter	Conditions	Min	Typ	Max	Unit
DIFFERENTIAL INPUT PERFORMANCE					
DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	$V_{O, dm} = 0.1\text{ V p-p}$	64	76		MHz
-3 dB Large Signal Bandwidth	$V_{O, dm} = 2\text{ V p-p}$	79	110		MHz
Slew Rate	$V_{O, dm} = 2\text{ V step}$		450		V/ μs
Settling Time to 0.02%	$V_{O, dm} = 3.5\text{ V step}$		100		ns
Overdrive Recovery Time	$G = 2$, $V_{i, dm} = 12\text{ V p-p triangle wave}$		85		ns
NOISE/HARMONIC PERFORMANCE					
SFDR	$V_{O, dm} = 2\text{ V p-p}$, $f_c = 500\text{ kHz}$		90		dB
	$V_{O, dm} = 2\text{ V p-p}$, $f_c = 2\text{ MHz}$		76		dB
Input Voltage Noise	$f = 50\text{ kHz to }1\text{ MHz}$		8.25		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	$f = 50\text{ kHz to }1\text{ MHz}$		1		pA/ $\sqrt{\text{Hz}}$
DC PERFORMANCE					
Input Offset Voltage	$V_{IP} = V_{IN} = V_{OCM} = 0\text{ V}$	-2.6	± 0.7	+2.6	mV
Input Offset Voltage Drift	T_{MIN} to T_{MAX}		3		$\mu\text{V}/^\circ\text{C}$
Input Bias Current	T_{MIN} to T_{MAX}		0.5	1	μA
Input Offset Current			0.1	0.45	μA
Open-Loop Gain			91		dB
INPUT CHARACTERISTICS					
Input Common-Mode Voltage Range		-4		+4	V
Input Resistance	Differential		800		k Ω
	Common-mode		400		k Ω
Input Capacitance	Common-mode		1.8		pF
CMRR	$\Delta V_{ICM} = \pm 1\text{ V}$	66	79		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	Each single-ended output, $R_{L, dm} = 1\text{ k}\Omega$	$V_{S-} + 0.55$		$V_{S+} - 0.55$	V
Output Current			20		mA
Output Balance Error	$f = 1\text{ MHz}$		-64		dB
V_{OCM} to $V_{O, cm}$ PERFORMANCE					
V_{OCM} DYNAMIC PERFORMANCE					
-3 dB Bandwidth	$V_{O, cm} = 0.1\text{ V p-p}$		58		MHz
Slew Rate	$V_{O, cm} = 0.5\text{ V p-p}$		63		V/ μs
Gain		0.992	1.000	1.008	V/V
V_{OCM} INPUT CHARACTERISTICS					
Input Voltage Range		-4		+4	V
Input Resistance			35		k Ω
Input Offset Voltage		-28	± 11	+28	mV
Input Voltage Noise	$f = 100\text{ kHz to }1\text{ MHz}$		18		nV/ $\sqrt{\text{Hz}}$
Input Bias Current			0.3	1.1	μA
CMRR	$\Delta V_{O, dm}/\Delta V_{OCM}$, $\Delta V_{OCM} = \pm 0.5\text{ V}$	62	75		dB
POWER SUPPLY					
Operating Range		+2.7		± 6	V
Quiescent Current			3.2	3.6	mA
Quiescent Current, Disabled	Power-down = low		750	900	μA
PSRR	$\Delta V_S = \pm 1\text{ V}$	79	91		dB
PD PIN					
Threshold Voltage		$V_{S-} + 0.7$		$V_{S-} + 1.7$	V
Input Current	Power-Down = high/low		150/210	170/240	μA
OPERATING TEMPERATURE RANGE					
		-40		+125	$^\circ\text{C}$

AD8137

$V_S = 5\text{ V}$, $V_{OCM} = 2.5\text{ V}$ (@ 25°C , differential gain = 1, $R_{L, dm} = R_F = R_G = 1\text{ k}\Omega$, unless otherwise noted, T_{MIN} to $T_{MAX} = -40^\circ\text{C}$ to $+125^\circ\text{C}$).

Table 2.

Parameter	Conditions	Min	Typ	Max	Unit
DIFFERENTIAL INPUT PERFORMANCE					
DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	$V_{O, dm} = 0.1\text{ V p-p}$	63	75		MHz
-3 dB Large Signal Bandwidth	$V_{O, dm} = 2\text{ V p-p}$	76	107		MHz
Slew Rate	$V_{O, dm} = 2\text{ V step}$		375		V/ μs
Settling Time to 0.02%	$V_{O, dm} = 3.5\text{ V step}$		110		ns
Overdrive Recovery Time	$G = 2$, $V_{I, dm} = 7\text{ V p-p triangle wave}$		90		ns
NOISE/HARMONIC PERFORMANCE					
SFDR	$V_{O, dm} = 2\text{ V p-p}$, $f_c = 500\text{ kHz}$		89		dB
	$V_{O, dm} = 2\text{ V p-p}$, $f_c = 2\text{ MHz}$		73		dB
Input Voltage Noise	$f = 50\text{ kHz to }1\text{ MHz}$		8.25		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	$f = 50\text{ kHz to }1\text{ MHz}$		1		pA/ $\sqrt{\text{Hz}}$
DC PERFORMANCE					
Input Offset Voltage	$V_{IP} = V_{IN} = V_{OCM} = 0\text{ V}$	-2.7	± 0.7	+2.7	mV
Input Offset Voltage Drift	T_{MIN} to T_{MAX}		3		$\mu\text{V}/^\circ\text{C}$
Input Bias Current	T_{MIN} to T_{MAX}		0.5	0.9	μA
Input Offset Current			0.1	0.45	μA
Open-Loop Gain			89		dB
INPUT CHARACTERISTICS					
Input Common-Mode Voltage Range		1		4	V
Input Resistance	Differential		800		k Ω
	Common-mode		400		k Ω
Input Capacitance	Common-mode		1.8		pF
CMRR	$\Delta V_{ICM} = \pm 1\text{ V}$	64	90		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	Each single-ended output, $R_{L, dm} = 1\text{ k}\Omega$	$V_{S-} + 0.45$		$V_{S+} - 0.45$	V
Output Current			20		mA
Output Balance Error	$f = 1\text{ MHz}$		-64		dB
V_{OCM} to $V_{O, cm}$ PERFORMANCE					
V_{OCM} DYNAMIC PERFORMANCE					
-3 dB Bandwidth	$V_{O, cm} = 0.1\text{ V p-p}$		60		MHz
Slew Rate	$V_{O, cm} = 0.5\text{ V p-p}$		61		V/ μs
Gain		0.980	1.000	1.020	V/V
V_{OCM} INPUT CHARACTERISTICS					
Input Voltage Range		1		4	V
Input Resistance			35		k Ω
Input Offset Voltage		-25	± 7.5	+25	mV
Input Voltage Noise	$f = 100\text{ kHz to }5\text{ MHz}$		18		nV/ $\sqrt{\text{Hz}}$
Input Bias Current			0.25	0.9	μA
CMRR	$\Delta V_{O, dm} / \Delta V_{OCM}$, $\Delta V_{OCM} = \pm 0.5\text{ V}$	62	75		dB
POWER SUPPLY					
Operating Range		+2.7		± 6	V
Quiescent Current			2.6	2.8	mA
Quiescent Current, Disabled	Power-down = low		450	600	μA
PSRR	$\Delta V_S = \pm 1\text{ V}$	79	91		dB
PD PIN					
Threshold Voltage		$V_{S-} + 0.7$		$V_{S-} + 1.5$	V
Input Current	Power-down = high/low		50/110	60/120	μA
OPERATING TEMPERATURE RANGE					
		-40		+125	$^\circ\text{C}$

$V_S = 3\text{ V}$, $V_{OCM} = 1.5\text{ V}$ (@ 25°C , differential gain = 1, $R_{L, dm} = R_F = R_G = 1\text{ k}\Omega$, unless otherwise noted, T_{MIN} to $T_{MAX} = -40^\circ\text{C}$ to $+125^\circ\text{C}$).

Table 3.

Parameter	Conditions	Min	Typ	Max	Unit
DIFFERENTIAL INPUT PERFORMANCE					
DYNAMIC PERFORMANCE					
–3 dB Small Signal Bandwidth	$V_{O, dm} = 0.1\text{ V p-p}$	61	73		MHz
–3 dB Large Signal Bandwidth	$V_{O, dm} = 2\text{ V p-p}$	62	93		MHz
Slew Rate	$V_{O, dm} = 2\text{ V Step}$		340		V/ μs
Settling Time to 0.02%	$V_{O, dm} = 3.5\text{ V Step}$		110		ns
Overdrive Recovery Time	$G = 2$, $V_{I, dm} = 5\text{ V p-p Triangle Wave}$		100		ns
NOISE/HARMONIC PERFORMANCE					
SFDR	$V_{O, dm} = 2\text{ V p-p}$, $f_c = 500\text{ kHz}$		89		dB
	$V_{O, dm} = 2\text{ V p-p}$, $f_c = 2\text{ MHz}$		71		dB
Input Voltage Noise	$f = 50\text{ kHz to }1\text{ MHz}$		8.25		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	$f = 50\text{ kHz to }1\text{ MHz}$		1		pA/ $\sqrt{\text{Hz}}$
DC PERFORMANCE					
Input Offset Voltage	$V_{IP} = V_{IN} = V_{OCM} = 0\text{ V}$	–2.75	± 0.7	+2.75	mV
Input Offset Voltage Drift	T_{MIN} to T_{MAX}		3		$\mu\text{V}/^\circ\text{C}$
Input Bias Current	T_{MIN} to T_{MAX}		0.5	0.9	μA
Input Offset Current			0.1	0.4	μA
Open-Loop Gain			87		dB
INPUT CHARACTERISTICS					
Input Common-Mode Voltage Range		1		2	V
Input Resistance	Differential		800		M Ω
	Common-mode		400		M Ω
Input Capacitance	Common-mode		1.8		pF
CMRR	$\Delta V_{ICM} = \pm 1\text{ V}$	64	80		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	Each single-ended output, $R_{L, dm} = 1\text{ k}\Omega$	$V_{S-} + 0.37$		$V_{S+} - 0.37$	V
Output Current			20		mA
Output Balance Error	$f = 1\text{ MHz}$		–64		dB
V_{OCM} to $V_{O, cm}$ PERFORMANCE					
V_{OCM} DYNAMIC PERFORMANCE					
–3 dB Bandwidth	$V_{O, cm} = 0.1\text{ V p-p}$		61		MHz
Slew Rate	$V_{O, cm} = 0.5\text{ V p-p}$		59		V/ μs
Gain		0.96	1.00	1.04	V/V
V_{OCM} INPUT CHARACTERISTICS					
Input Voltage Range		1.0		2.0	V
Input Resistance			35		k Ω
Input Offset Voltage		–25	± 5.5	+25	mV
Input Voltage Noise	$f = 100\text{ kHz to }5\text{ MHz}$		18		nV/ $\sqrt{\text{Hz}}$
Input Bias Current			0.3	0.7	μA
CMRR	$\Delta V_{O, dm} / \Delta V_{OCM}, \Delta V_{OCM} = \pm 0.5\text{ V}$	62	74		dB
POWER SUPPLY					
Operating Range		+2.7		± 6	V
Quiescent Current			2.3	2.5	mA
Quiescent Current, Disabled	Power-down = low		345	460	μA
PSRR	$\Delta V_S = \pm 1\text{ V}$	78	90		dB
PD PIN					
Threshold Voltage		$V_{S-} + 0.7$		$V_{S-} + 1.5$	V
Input Current	Power-down = high/low		8/65	10/70	μA
OPERATING TEMPERATURE RANGE					
		–40		+125	$^\circ\text{C}$

ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	Rating
Supply Voltage	12 V
V_{OCM}	V_{S+} to V_{S-}
Power Dissipation	See Figure 3
Input Common-Mode Voltage	V_{S+} to V_{S-}
Storage Temperature	-65°C to +125°C
Operating Temperature Range	-40°C to +125°C
Lead Temperature (Soldering 10 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions, that is, θ_{JA} is specified for the device soldered in a circuit board in still air.

Table 5. Thermal Resistance

Package Type	θ_{JA}	θ_{JC}	Unit
SOIC-8/2-Layer	157	56	°C/W
SOIC-8/4-Layer	125	56	°C/W
LFCSP/4-Layer	70	56	°C/W

Maximum Power Dissipation

The maximum safe power dissipation in the AD8137 package is limited by the associated rise in junction temperature (T_J) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit may change the stresses that the package exerts on the die, permanently shifting the parametric performance of the AD8137. Exceeding a junction temperature of 175°C for an extended period of time can result in changes in the silicon devices, potentially causing failure.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

The power dissipated in the package (P_D) is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive for all outputs. The quiescent power is the voltage between the supply pins (V_S) times the quiescent current (I_S). The load current consists of differential and common-mode currents flowing to the load, as well as currents flowing through the external feedback networks and the internal common-mode feedback loop. The internal resistor tap used in the common-mode feedback loop places a 1 k Ω differential load on the output. RMS output voltages should be considered when dealing with ac signals.

Airflow reduces θ_{JA} . Also, more metal directly in contact with the package leads from metal traces, through holes, ground, and power planes reduces the θ_{JA} .

Figure 3 shows the maximum safe power dissipation in the package vs. the ambient temperature for the SOIC-8 (125°C/W) and LFCSP ($\theta_{JA} = 70^\circ\text{C/W}$) package on a JEDEC standard 4-layer board. θ_{JA} values are approximations.

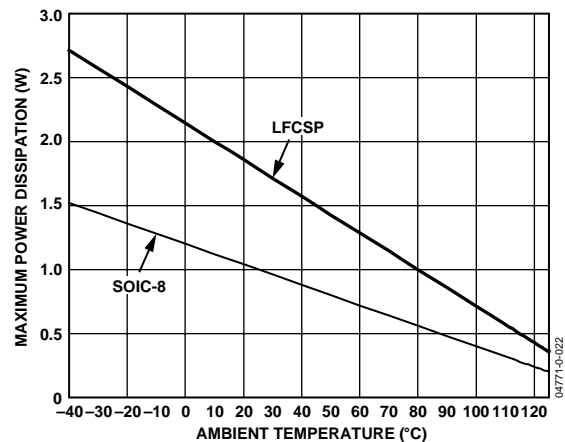


Figure 3. Maximum Power Dissipation vs. Temperature for a 4-Layer Board



PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

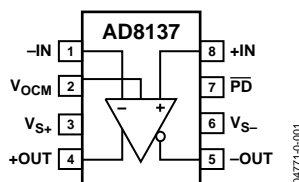


Figure 4. Pin Configuration

Table 6. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	-IN	Inverting Input.
2	V _{OCM}	An internal feedback loop drives the output common-mode voltage to be equal to the voltage applied to the V _{OCM} pin, provided the amplifier's operation remains linear.
3	V _{S+}	Positive Power Supply Voltage.
4	+OUT	Positive Side of the Differential Output.
5	-OUT	Negative Side of the Differential Output.
6	V _{S-}	Negative Power Supply Voltage.
7	PD	Power Down.
8	+IN	Noninverting Input.

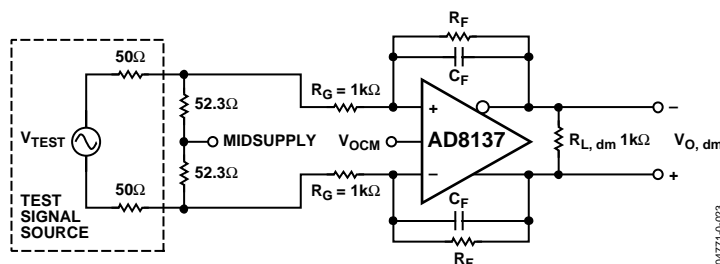


Figure 5. Basic Test Circuit

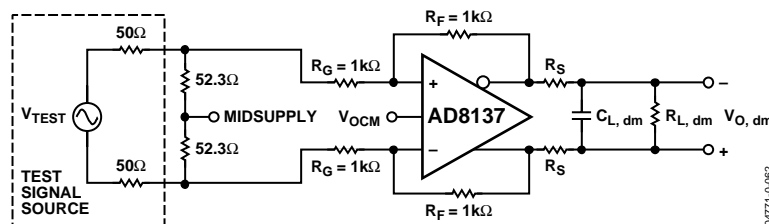


Figure 6. Capacitive Load Test Circuit, G = 1

TYPICAL PERFORMANCE CHARACTERISTICS

Unless otherwise noted, differential gain = 1, $R_G = R_F = R_{L, dm} = 1\text{ k}\Omega$, $V_S = 5\text{ V}$, $T_A = 25^\circ\text{C}$, $V_{OCM} = 2.5\text{V}$. Refer to the basic test circuit in Figure 5 for the definition of terms.

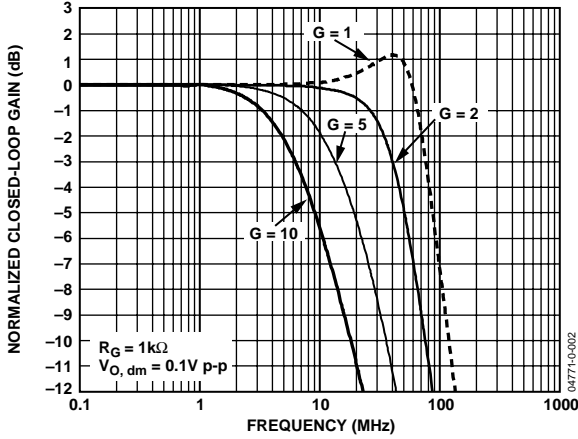


Figure 7. Small Signal Frequency Response for Various Gains

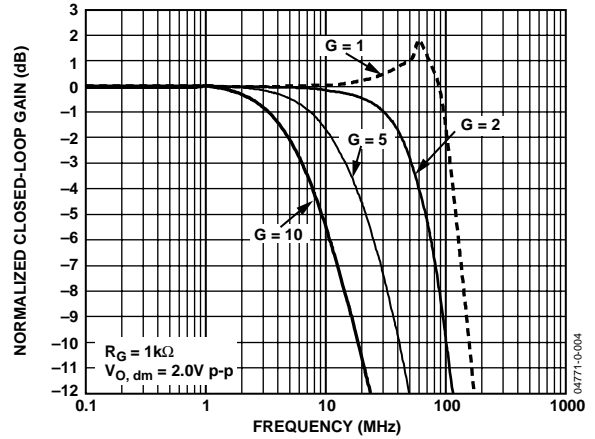


Figure 10. Large Signal Frequency Response for Various Gains

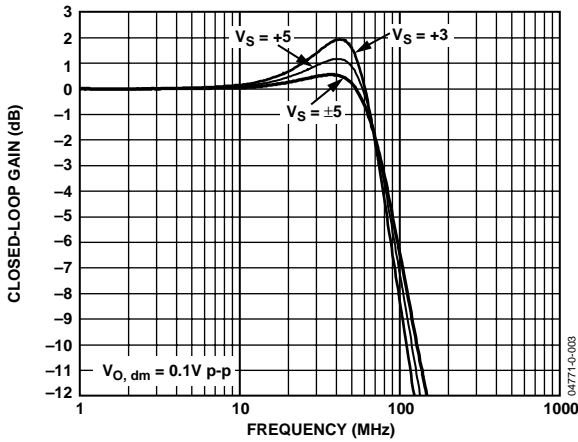


Figure 8. Small Signal Frequency Response for Various Power Supplies

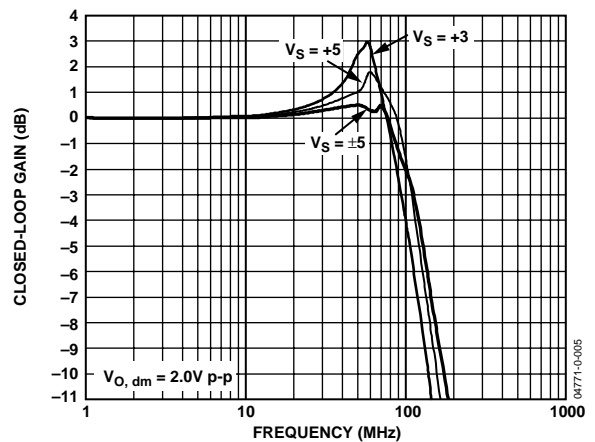


Figure 11. Large Signal Frequency Response for Various Power Supplies

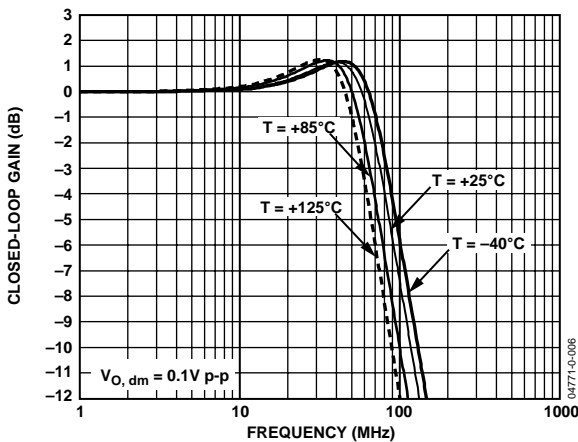


Figure 9. Small Signal Frequency Response at Various Temperatures

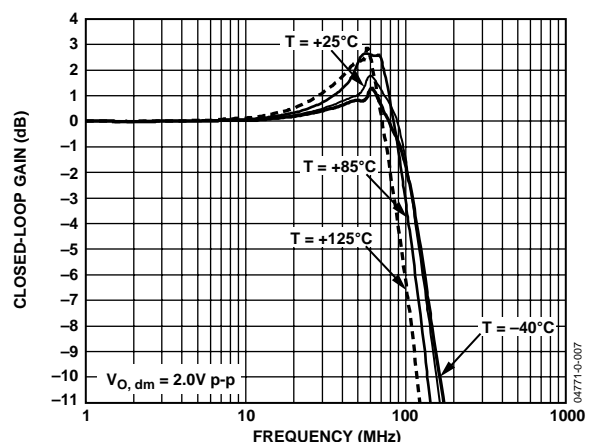


Figure 12. Large Signal Frequency Response at Various Temperatures

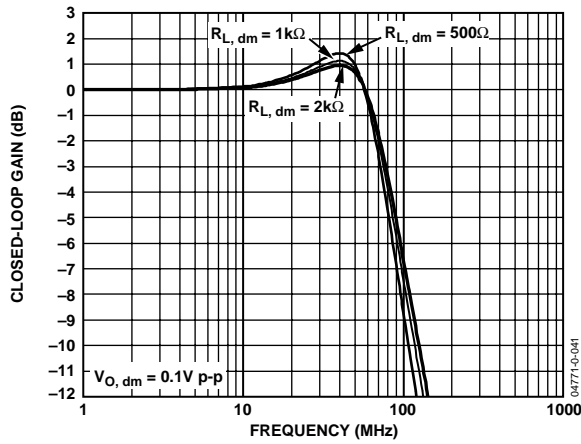


Figure 13. Small Signal Frequency Response for Various Loads

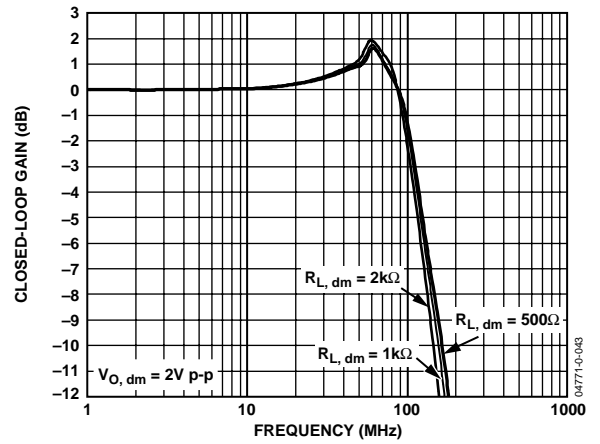


Figure 16. Large Signal Frequency Response for Various Loads

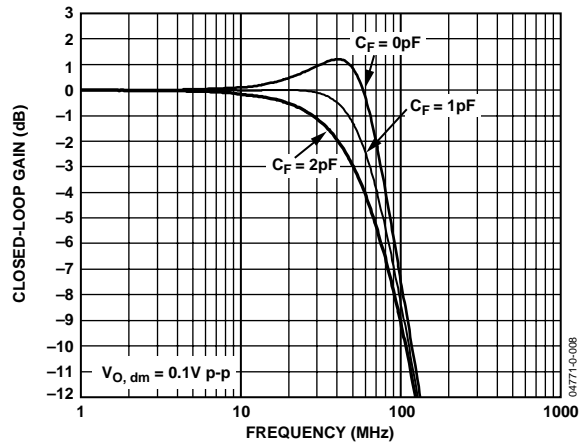


Figure 14. Small Signal Frequency Response for Various C_F

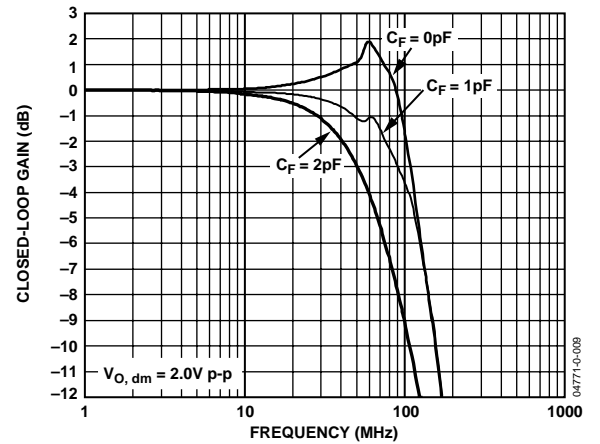


Figure 17. Large Signal Frequency Response for Various C_F

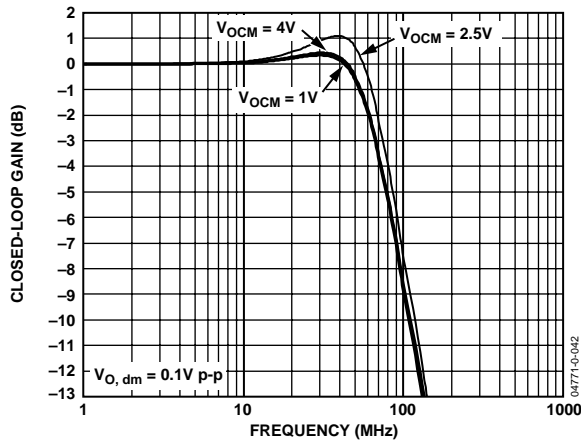


Figure 15. Small Signal Frequency Response at Various V_{OCM}

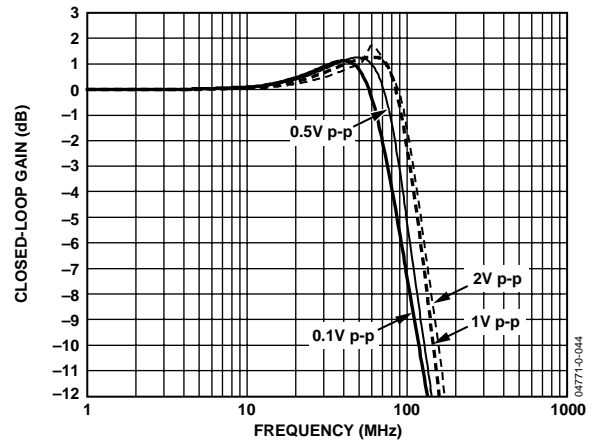


Figure 18. Frequency Response for Various Output Amplitudes

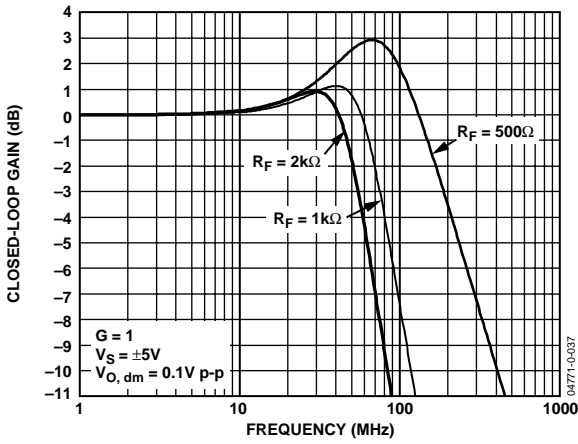


Figure 19. Small Signal Frequency Response for Various R_f

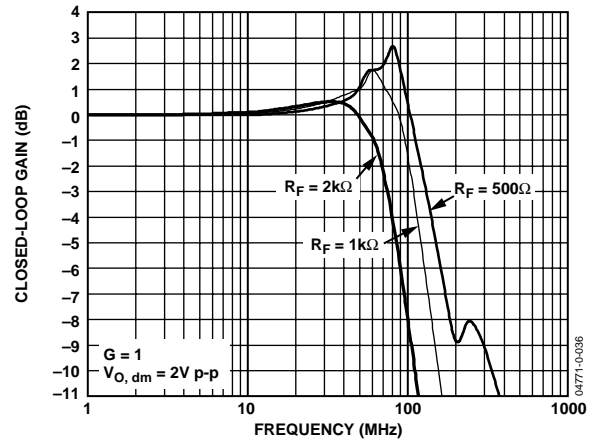


Figure 22. Large Signal Frequency Response for Various R_f

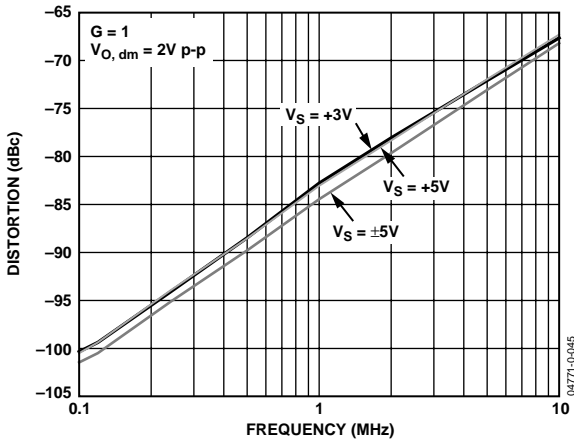


Figure 20. Second Harmonic Distortion vs. Frequency and Supply Voltage

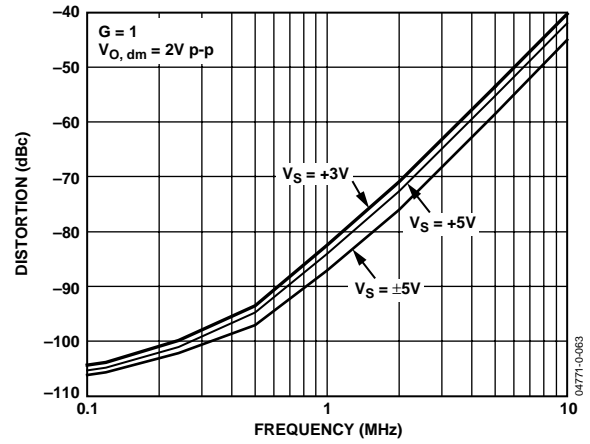


Figure 23. Third Harmonic Distortion vs. Frequency and Supply Voltage

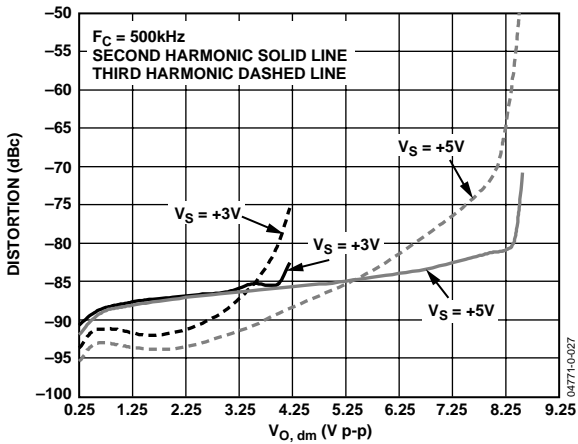


Figure 21. Harmonic Distortion vs. Output Amplitude and Supply, $F_c = 500 \text{ kHz}$

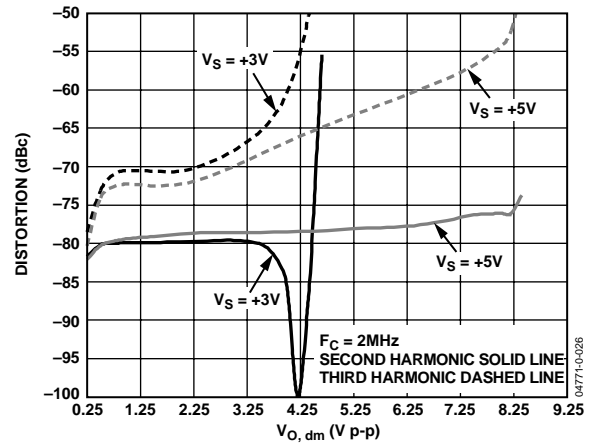


Figure 24. Harmonic Distortion vs. Output Amplitude and Supply, $F_c = 2 \text{ MHz}$

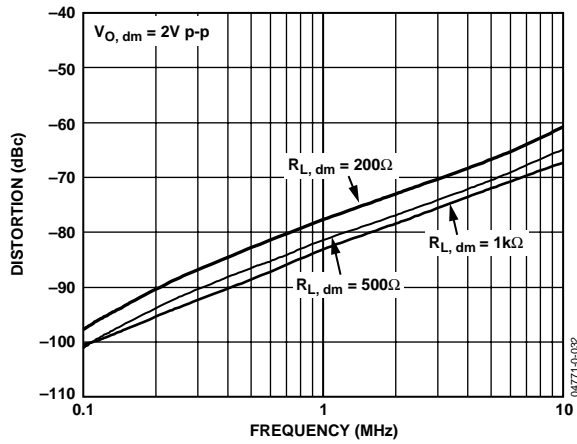


Figure 25. Second Harmonic Distortion at Various Loads

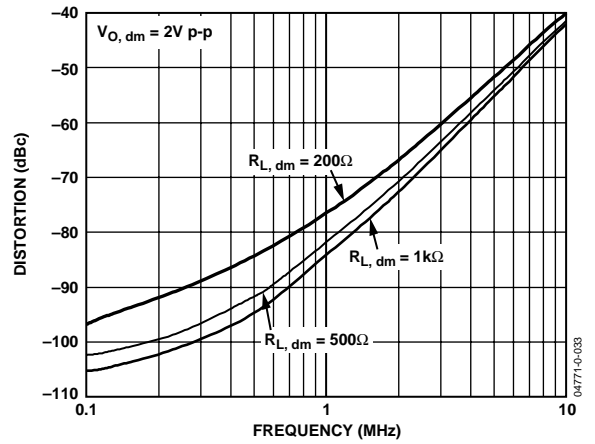


Figure 28. Third Harmonic Distortion at Various Loads

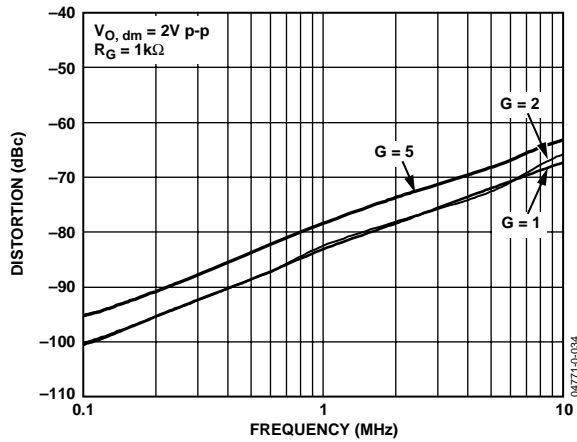


Figure 26. Second Harmonic Distortion at Various Gains

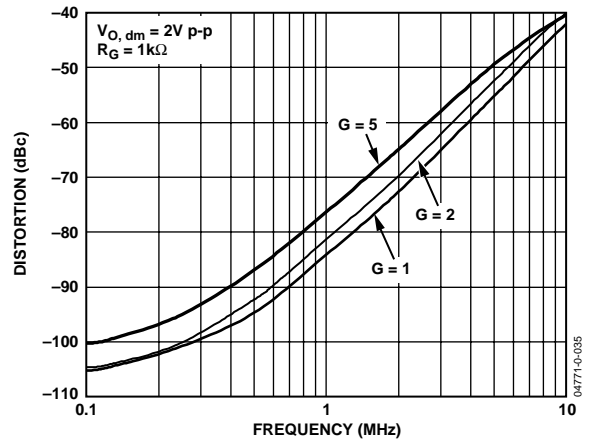


Figure 29. Third Harmonic Distortion at Various Gains

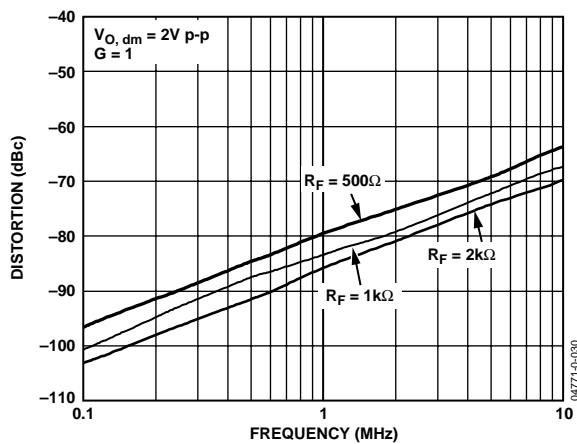


Figure 27. Second Harmonic Distortion at Various R_F

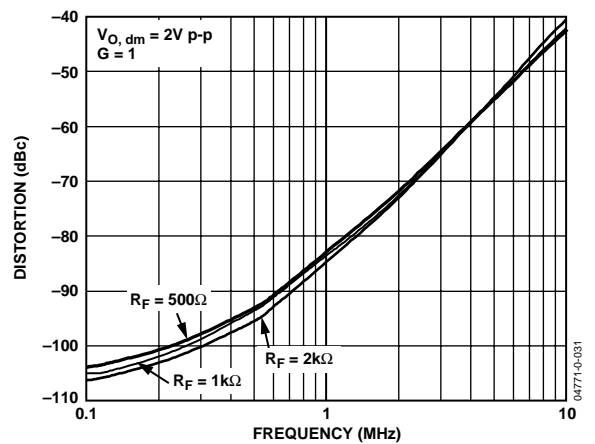


Figure 30. Third Harmonic Distortion at Various R_F

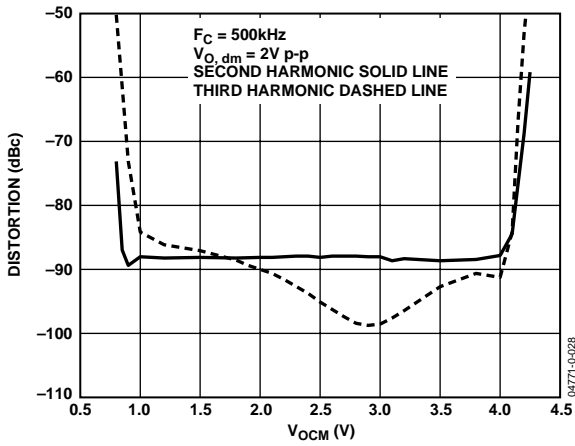


Figure 31. Harmonic Distortion vs. V_{OCM} , $V_S = 5\text{V}$

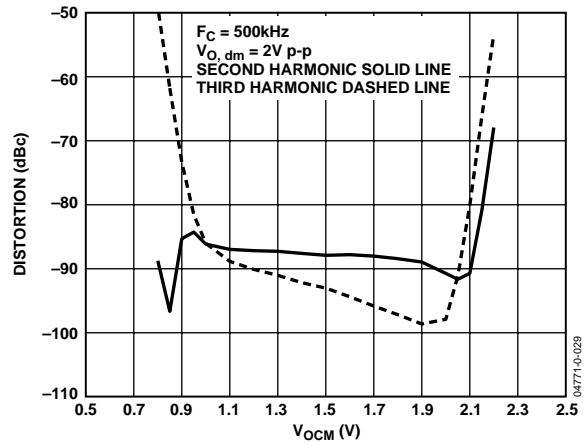


Figure 34. Harmonic Distortion vs. V_{OCM} , $V_S = 3\text{V}$

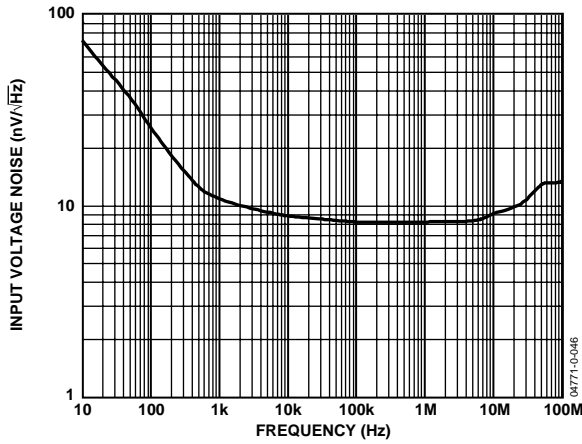


Figure 32. Input Voltage Noise vs. Frequency

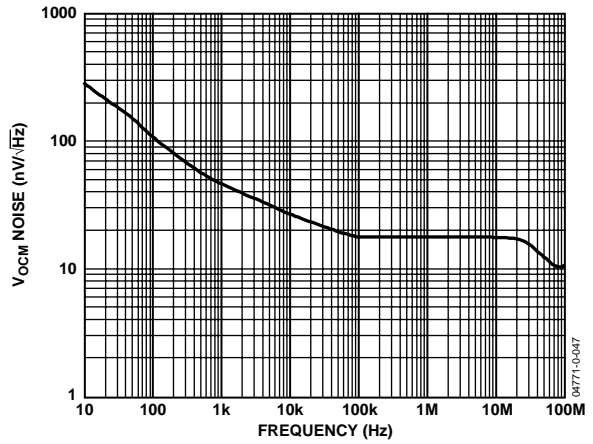


Figure 35. V_{OCM} Voltage Noise vs. Frequency

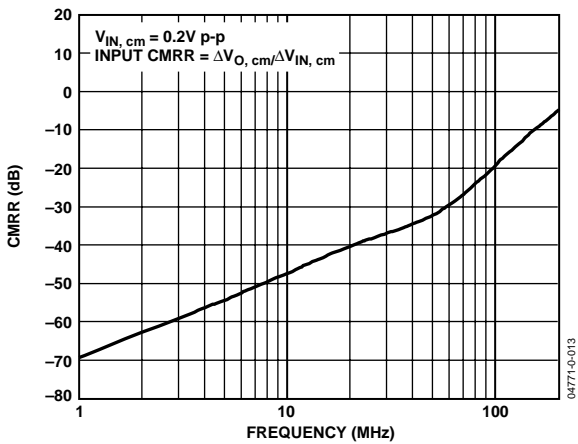


Figure 33. CMRR vs. Frequency

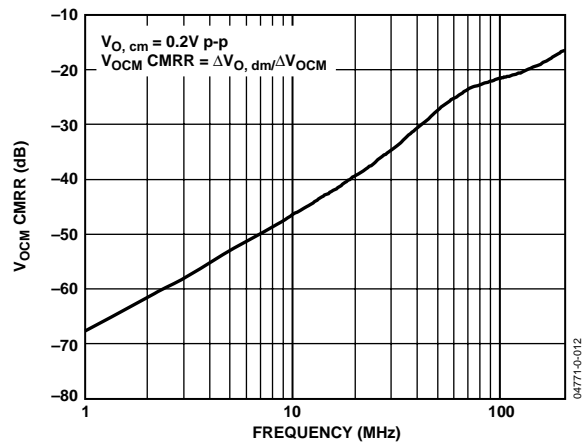


Figure 36. V_{OCM} CMRR vs. Frequency

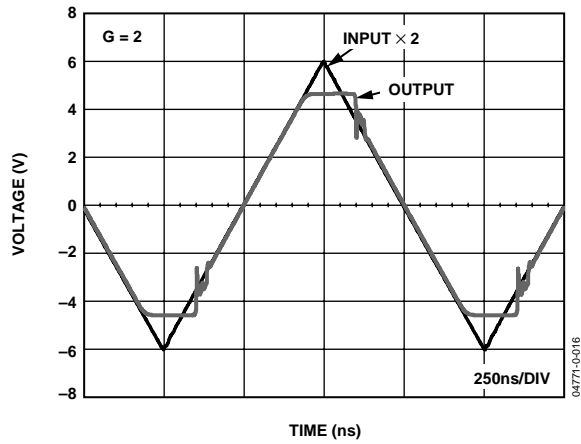


Figure 37. Overdrive Recovery

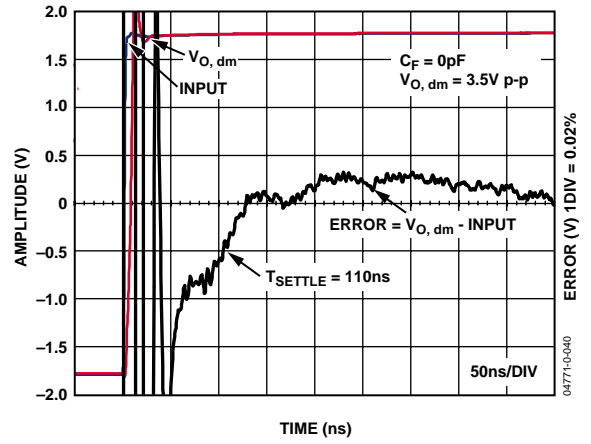


Figure 40. Settling Time (0.02%)

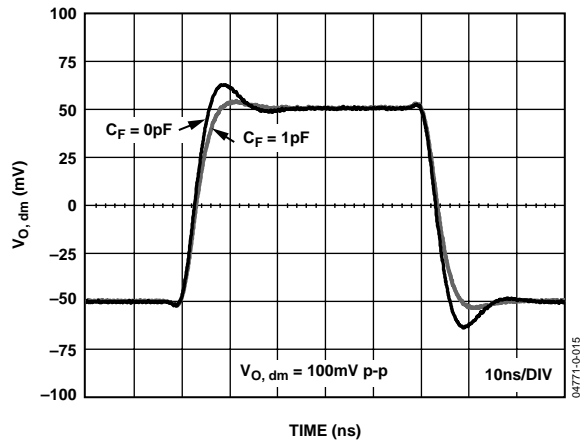


Figure 38. Small Signal Transient Response for Various Feedback Capacitances

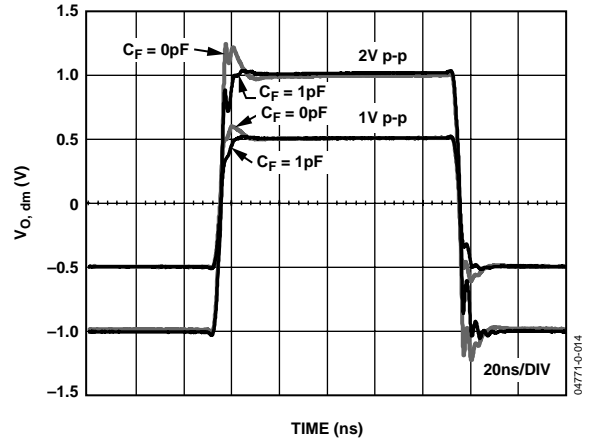


Figure 41. Large Signal Transient Response for Various Feedback Capacitances

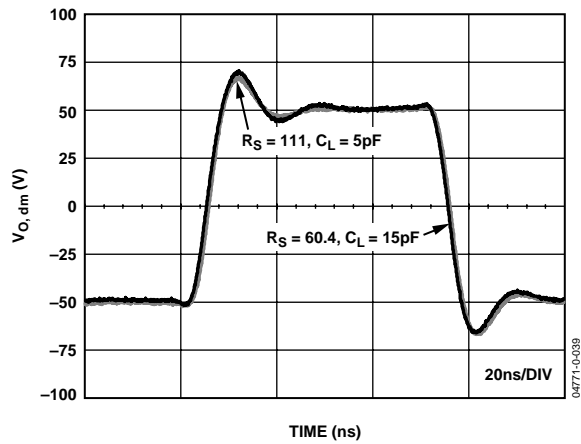


Figure 39. Small Signal Transient Response for Various Capacitive Loads

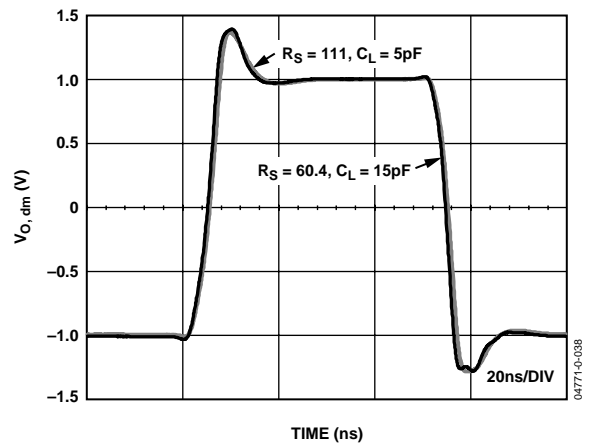


Figure 42. Large Signal Transient Response for Various Capacitive Loads

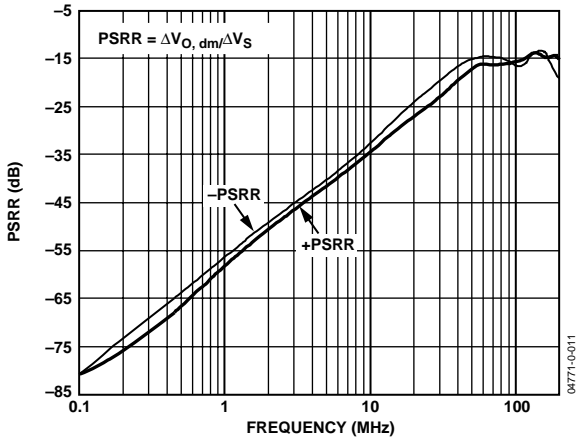


Figure 43. PSRR vs. Frequency

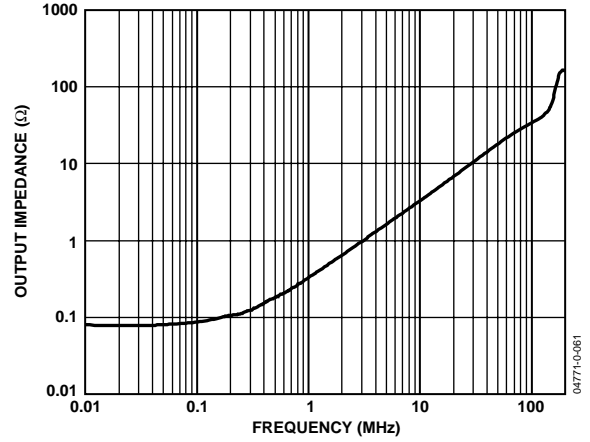


Figure 46. Single-Ended Output Impedance vs. Frequency

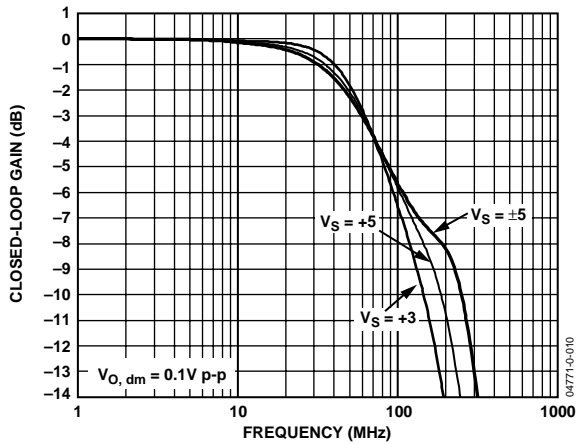


Figure 44. V_{OCM} Small Signal Frequency Response for Various Supply Voltages

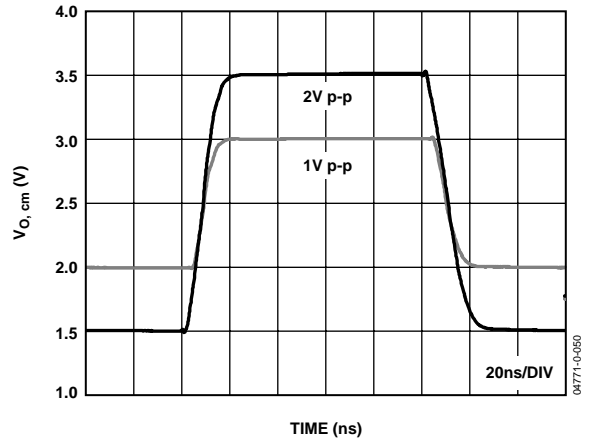


Figure 47. V_{OCM} Large Signal Transient Response

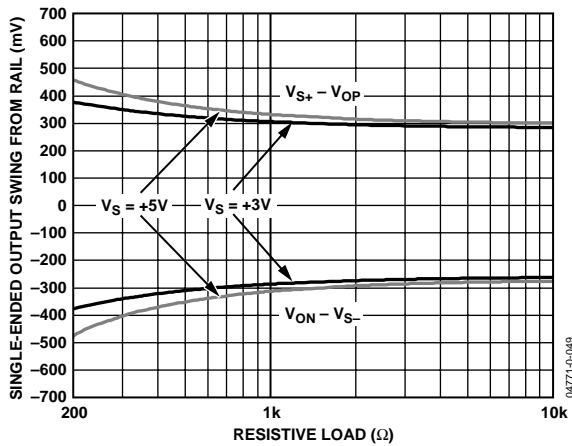


Figure 45. Output Saturation Voltage vs. Output Load

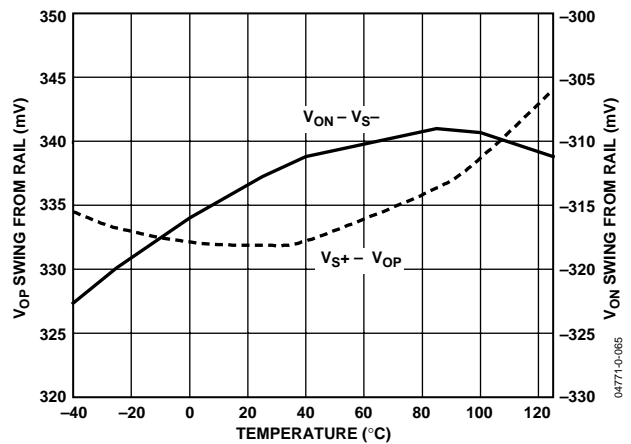


Figure 48. Output Saturation Voltage vs. Temperature

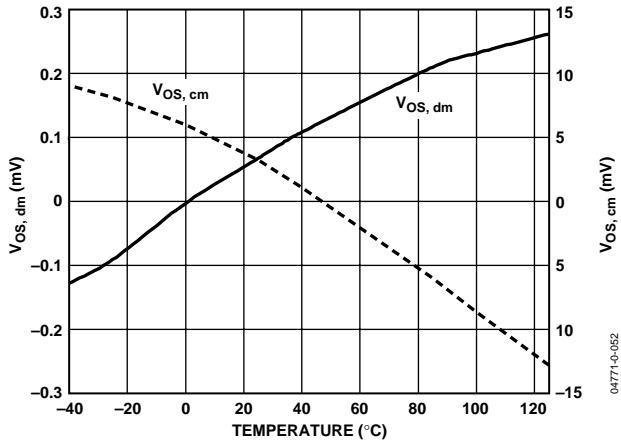


Figure 49. Offset Voltage vs. Temperature

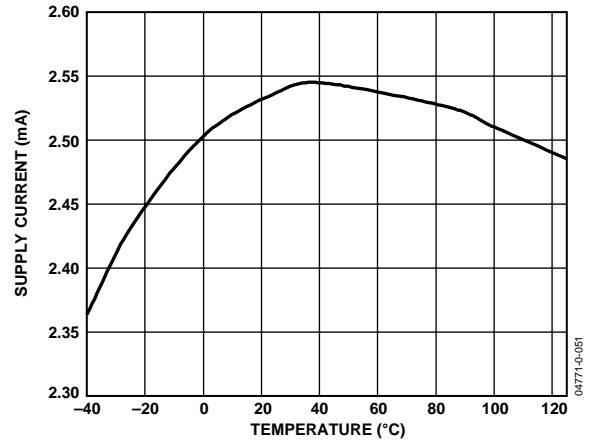


Figure 52. Supply Current vs. Temperature

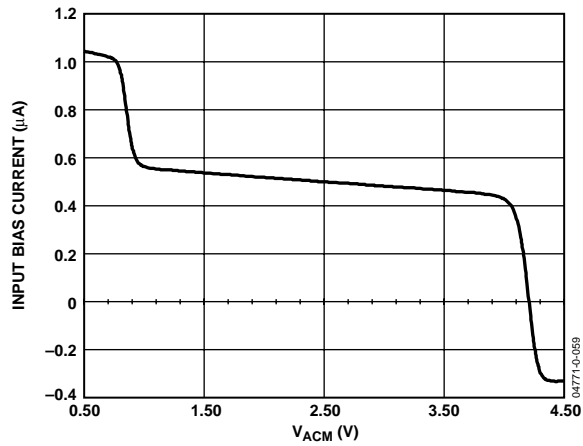


Figure 50. Input Bias Current vs. Input Common-Mode Voltage, VACM

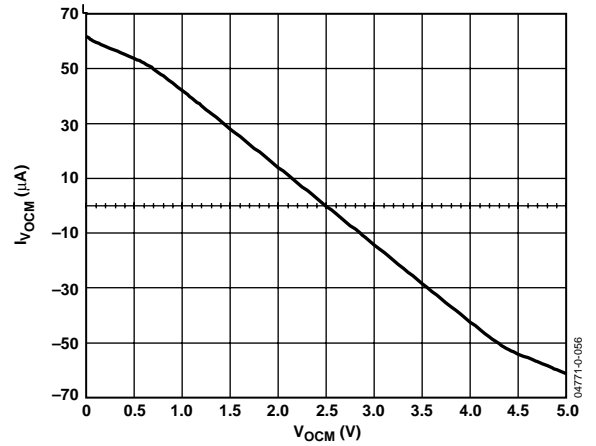


Figure 53. Vocm Bias Current vs. Vocm Input Voltage

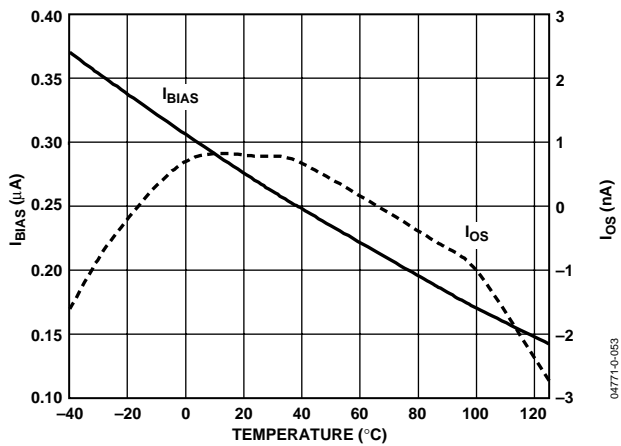


Figure 51. Input Bias and Offset Current vs. Temperature

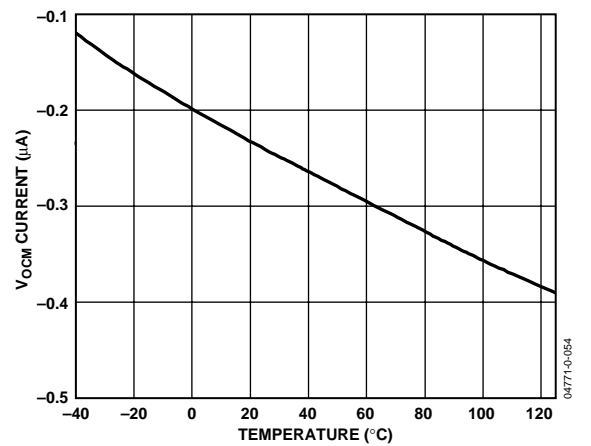


Figure 54. Vocm Bias Current vs. Temperature

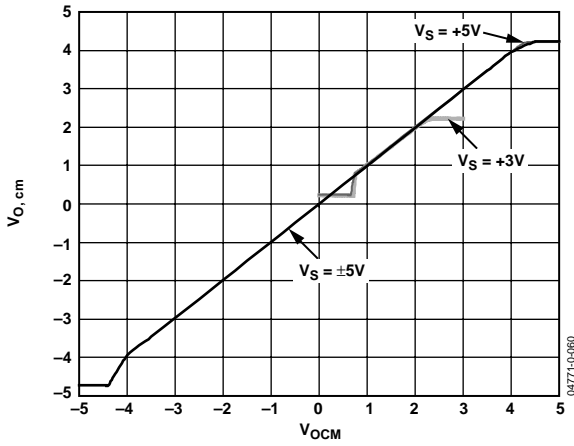


Figure 55. $V_{O,cm}$ vs. V_{OCM} Input Voltage

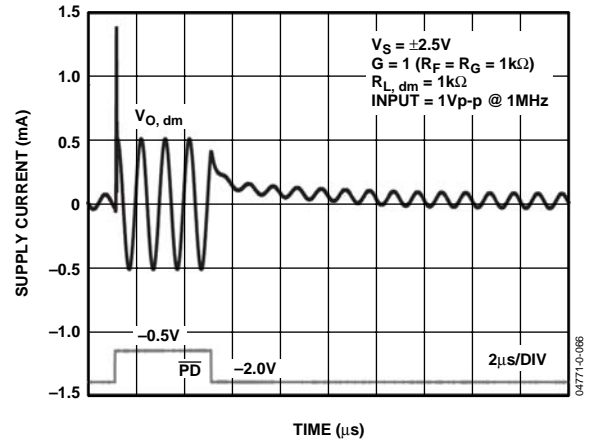


Figure 58. Power-Down Transient Response

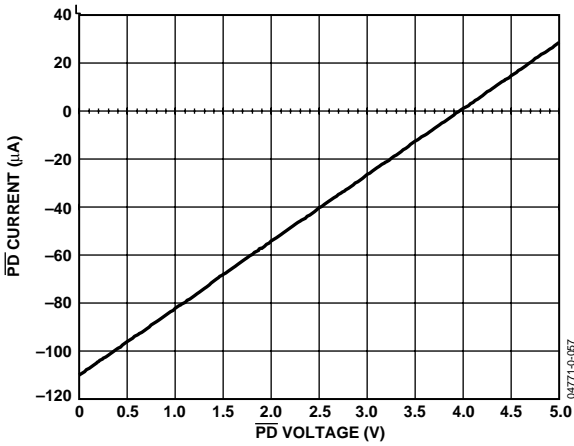


Figure 56. \overline{PD} Current vs. \overline{PD} Voltage

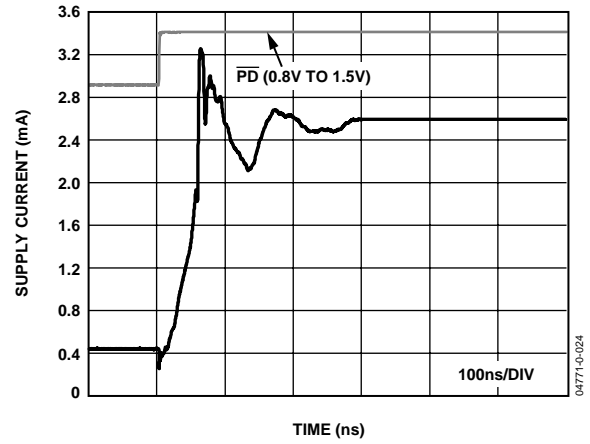


Figure 59. Power-Down Turn-On Time

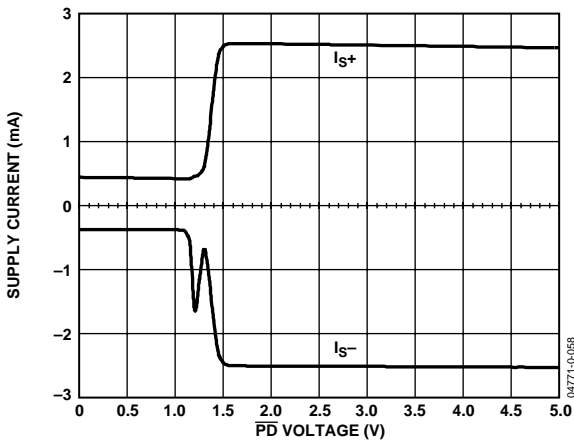


Figure 57. Supply Current vs. \overline{PD} Voltage

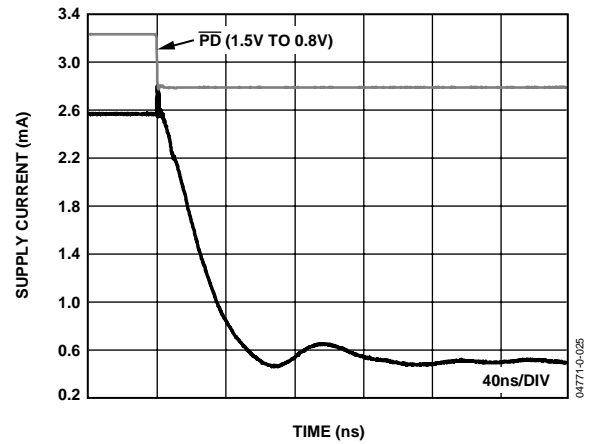


Figure 60. Power-Down Turn-Off Time

THEORY OF OPERATION

The AD8137 is a low power, low cost, fully differential voltage feedback amplifier that features a rail-to-rail output stage, common-mode circuitry with an internally derived common-mode reference voltage, and bias shutdown circuitry. The amplifier uses two feedback loops to separately control differential and common-mode feedback. The differential gain is set with external resistors as in a traditional amplifier while the output common-mode voltage is set by an internal feedback loop, controlled by an external V_{OCM} input. This architecture makes it easy to arbitrarily set the output common-mode voltage level without affecting the differential gain of the amplifier.

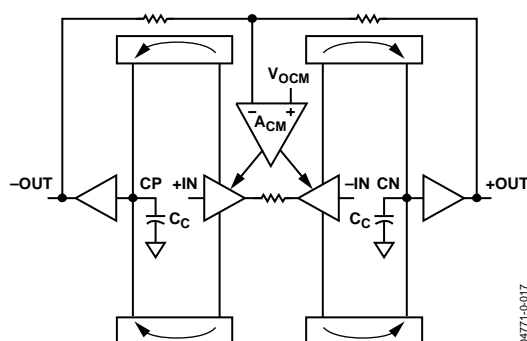


Figure 61. Block Diagram

From Figure 61, the input transconductance stage is an H-bridge whose output current is mirrored to high impedance nodes CP and CN. The output section is traditional H-bridge driven circuitry with common emitter devices driving nodes +OUT and -OUT. The 3 dB point of the amplifier is defined as

$$BW = \frac{g_m}{2\pi \times C_c}$$

where g_m is the transconductance of the input stage and C_c is the total capacitance on node CP/CN (capacitances CP and CN are well matched). For the AD8137, the input stage g_m is ~ 1 mA/V and the capacitance C_c is 3.5 pF, setting the crossover frequency of the amplifier at 41 MHz. This frequency generally establishes an amplifier's unity gain bandwidth, but with the AD8137, the closed-loop bandwidth depends upon the feedback resistor value as well (see Figure 19). The open-loop gain and phase simulations are shown in Figure 62.

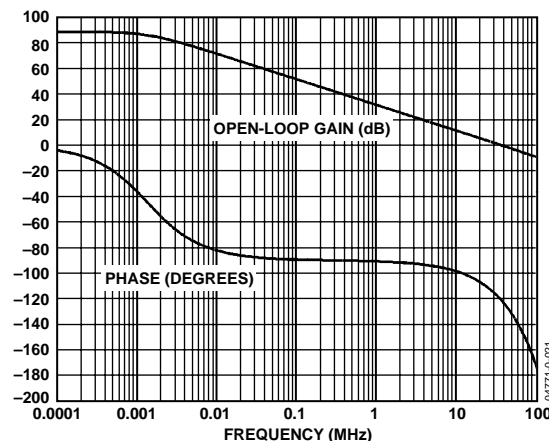


Figure 62. Open-Loop Gain and Phase

In Figure 61, the common-mode feedback amplifier A_{CM} samples the output common-mode voltage, and by negative feedback forces the output common-mode voltage to be equal to the voltage applied to the V_{OCM} input. In other words, the feedback loop servos the output common-mode voltage to the voltage applied to the V_{OCM} input. An internal bias generator sets the V_{OCM} level to approximately midsupply; therefore, the output common-mode voltage will be set to approximately midsupply when the V_{OCM} input is left floating. The source resistance of the internal bias generator is large and can be overridden easily by an external voltage supplied by a source with a relatively small output resistance. The V_{OCM} input can be driven to within approximately 1 V of the supply rails while maintaining linear operation in the common-mode feedback loop.

The common-mode feedback loop inside the AD8137 produces outputs that are highly balanced over a wide frequency range without the requirement of tightly matched external components, because it forces the signal component of the output common-mode voltage to be zeroed. The result is nearly perfectly balanced differential outputs of identical amplitude and exactly 180° apart in phase.

APPLICATIONS

ANALYZING A TYPICAL APPLICATION WITH MATCHED R_F AND R_G NETWORKS

Typical Connection and Definition of Terms

Figure 63 shows a typical connection for the AD8137, using matched external R_F/R_G networks. The differential input terminals of the AD8137, V_{AP} and V_{AN} , are used as summing junctions. An external reference voltage applied to the V_{OCM} terminal sets the output common-mode voltage. The two output terminals, V_{OP} and V_{ON} , move in opposite directions in a balanced fashion in response to an input signal.

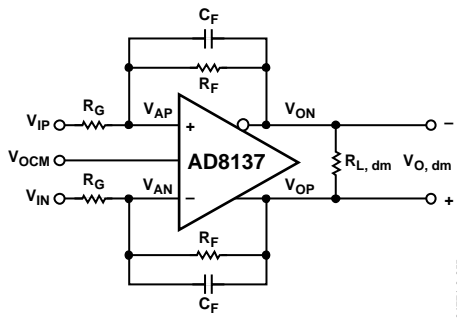


Figure 63. Typical Connection

The differential output voltage is defined as

$$V_{O, dm} = V_{OP} - V_{ON} \quad (1)$$

Common-mode voltage is the average of two voltages. The output common-mode voltage is defined as

$$V_{O, cm} = \frac{V_{OP} + V_{ON}}{2} \quad (2)$$

Output Balance

Output balance is a measure of how well V_{OP} and V_{ON} are matched in amplitude and how precisely they are 180° out of phase with each other. It is the internal common-mode feedback loop that forces the signal component of the output common-mode towards zero, resulting in the near perfectly balanced differential outputs of identical amplitude and exactly 180° out of phase. The output balance performance does not require tightly matched external components, nor does it require that the feedback factors of each loop be equal to each other. Low frequency output balance is ultimately limited by the mismatch of an on-chip voltage divider.

Output balance is measured by placing a well-matched resistor divider across the differential voltage outputs and comparing the signal at the divider's midpoint with the magnitude of the differential output. By this definition, output balance is equal to the magnitude of the change in output common-mode voltage divided by the magnitude of the change in output differential-mode voltage:

$$\text{Output Balance} = \left| \frac{\Delta V_{O, cm}}{\Delta V_{O, dm}} \right| \quad (3)$$

The differential negative feedback drives the voltages at the summing junctions V_{AN} and V_{AP} to be essentially equal to each other.

$$V_{AN} = V_{AP} \quad (4)$$

The common-mode feedback loop drives the output common-mode voltage, sampled at the midpoint of the two internal common-mode tap resistors in Figure 61, to equal the voltage set at the V_{OCM} terminal. This ensures that

$$V_{OP} = V_{OCM} + \frac{V_{O, dm}}{2} \quad (5)$$

and

$$V_{ON} = V_{OCM} - \frac{V_{O, dm}}{2} \quad (6)$$

ESTIMATING NOISE, GAIN, AND BANDWIDTH WITH MATCHED FEEDBACK NETWORKS

Estimating Output Noise Voltage and Bandwidth

The total output noise is the root-sum-squared total of several statistically independent sources. Since the sources are statistically independent, the contributions of each must be individually included in the root-sum-square calculation. Table 7 lists recommended resistor values and estimates of bandwidth and output differential voltage noise for various closed-loop gains. For most applications, 1% resistors are sufficient.

Table 7. Recommended Values of Gain-Setting Resistors, and Voltage Gain for Various Closed-Loop Gains

Gain	R_G (Ω)	R_F (Ω)	3 dB Bandwidth (MHz)	Total Output Noise (nV/ $\sqrt{\text{Hz}}$)
1	1 k	1 k	72	18.6
2	1 k	2 k	40	28.9
5	1 k	5 k	12	60.1
10	1 k	10 k	6	112.0

The differential output voltage noise contains contributions from the AD8137's input voltage noise and input current noise as well as those from the external feedback networks.

The contribution from the input voltage noise spectral density is computed as

$$V_{O_n1} = v_n \left(1 + \frac{R_F}{R_G} \right), \text{ or equivalently, } v_n / \beta \quad (7)$$

where v_n is defined as the input-referred differential voltage noise. This equation is the same as that of traditional op amps.

The contribution from the input current noise of each input is computed as

$$V_{O_n2} = i_n (R_F) \quad (8)$$

where i_n is defined as the input noise current of one input. Each input needs to be treated separately since the two input currents are statistically independent processes.

The contribution from each R_G is computed as

$$V_{O_n3} = \sqrt{4kTR_G} \left(\frac{R_F}{R_G} \right) \quad (9)$$

This result can be intuitively viewed as the thermal noise of each R_G multiplied by the magnitude of the differential gain.

The contribution from each R_F is computed as

$$V_{O_n4} = \sqrt{4kTR_F} \quad (10)$$

Voltage Gain

The behavior of the node voltages of the single-ended-to-differential output topology can be deduced from the signal definitions and Figure 63. Referring to Figure 63, ($C_F = 0$) and setting $V_{IN} = 0$ one can write:

$$\frac{V_{IP} - V_{AP}}{R_G} = \frac{V_{AP} - V_{ON}}{R_F} \quad (11)$$

$$V_{AN} = V_{AP} = V_{OP} \left[\frac{R_G}{R_F + R_G} \right] \quad (12)$$

Solving the above two equations and setting V_{IP} to V_i gives the gain relationship for $V_{O, dm} / V_i$.

$$V_{OP} - V_{ON} = V_{O, dm} = \frac{R_F}{R_G} V_i \quad (13)$$

An inverting configuration with the same gain magnitude can be implemented by simply applying the input signal to V_{IN} and setting $V_{IP} = 0$. For a balanced differential input, the gain from $V_{IN, dm}$ to $V_{O, dm}$ is also equal to R_F / R_G , where $V_{IN, dm} = V_{IP} - V_{IN}$.

Feedback Factor Notation

When working with differential drivers, it is convenient to introduce the feedback factor β , which is defined as

$$\beta \equiv \frac{R_G}{R_F + R_G} \quad (14)$$

This notation is consistent with conventional feedback analysis and is very useful, particularly when the two feedback loops are not matched.

Input Common-Mode Voltage

The linear range of the V_{AN} and V_{AP} terminals extends to within approximately 1 V of either supply rail. Since V_{AN} and V_{AP} are essentially equal to each other, they are both equal to the amplifier's input common-mode voltage. Their range is indicated in the specifications tables as input common-mode range. The voltage at V_{AN} and V_{AP} for the connection diagram in Figure 63 can be expressed as

$$V_{AN} = V_{AP} = V_{ACM} = \left(\frac{R_F}{R_F + R_G} \times \frac{(V_{IP} + V_{IN})}{2} \right) + \left(\frac{R_G}{R_F + R_G} \times V_{OCM} \right) \quad (15)$$

where V_{ACM} is the common-mode voltage present at the amplifier input terminals.

Using the β notation, Equation (15) can be written as

$$V_{ACM} = \beta V_{OCM} + (1 - \beta) V_{ICM} \quad (16)$$

or equivalently,

$$V_{ACM} = V_{ICM} + \beta (V_{OCM} - V_{ICM}) \quad (17)$$

where V_{ICM} is the common-mode voltage of the input signal, that is

$$V_{ICM} \equiv \frac{V_{IP} + V_{IN}}{2}$$

For proper operation, the voltages at V_{AN} and V_{AP} must stay within their respective linear ranges.

Calculating Input Impedance

The input impedance of the circuit in Figure 63 depends on whether the amplifier is being driven by a single-ended or a differential signal source. For balanced differential input signals, the differential input impedance ($R_{IN, dm}$) is simply

$$R_{IN, dm} = 2R_G \quad (18)$$

For a single-ended signal (for example, when V_{IN} is grounded, and the input signal drives V_{IP}), the input impedance becomes

$$R_{IN} = \frac{R_G}{1 - \frac{R_F}{2(R_G + R_F)}} \quad (19)$$

Estimating DC Errors

Primary differential output offset errors in the AD8137 are due to three major components: the input offset voltage, the offset between the V_{AN} and V_{AP} input currents interacting with the feedback network resistances, and the offset produced by the dc voltage difference between the input and output common-mode voltages in conjunction with matching errors in the feedback network.

The first output error component is calculated as

$$V_{o_e1} = V_{IO} \left(\frac{R_F + R_G}{R_G} \right), \text{ or equivalently as } V_{IO}/\beta \quad (21)$$

where V_{IO} is the input offset voltage.

The second error is calculated as

$$V_{o_e2} = I_{IO} \left(\frac{R_F + R_G}{R_G} \right) \left(\frac{R_G R_F}{R_F + R_G} \right) = I_{IO} (R_F) \quad (22)$$

where I_{IO} is defined as the offset between the two input bias currents.

The third error voltage is calculated as

$$V_{o_e3} = \Delta enr \times (V_{ICM} - V_{OCM}) \quad (23)$$

where Δenr is the fractional mismatch between the two feedback resistors.

The total differential offset error is the sum of these three error sources.

Additional Impact of Mismatches in the Feedback Networks

The internal common-mode feedback network will still force the output voltages to remain balanced, even when the R_F/R_G feedback networks are mismatched. The mismatch, however, will cause a gain error proportional to the feedback network mismatch.

Ratio-matching errors in the external resistors will degrade the ability to reject common-mode signals at the V_{AN} and V_{IN} input terminals, similar to a four-resistor difference amplifier made from a conventional op amp. Ratio-matching errors will also produce a differential output component that is equal to the V_{OCM} input voltage times the difference between the feedback factors (β s). In most applications using 1% resistors, this component amounts to a differential dc offset at the output that is small enough to be ignored.

Driving a Capacitive Load

A purely capacitive load will react with the bondwire and pin inductance of the AD8137, resulting in high frequency ringing in the transient response and loss of phase margin. One way to minimize this effect is to place a small resistor in series with each output to buffer the load capacitance. The resistor and load capacitance will form a first-order, low-pass filter, so the resistor value should be as small as possible. In some cases, the ADCs require small series resistors to be added on their inputs.

Figure 39 and Figure 42 illustrate transient response vs. capacitive load, and were generated using series resistors in each output and a differential capacitive load.

Layout Considerations

Standard high speed PCB layout practices should be adhered to when designing with the AD8137. A solid ground plane is recommended and good wideband power supply decoupling networks should be placed as close as possible to the supply pins.

To minimize stray capacitance at the summing nodes, the copper in all layers under all traces and pads that connect to the summing nodes should be removed. Small amounts of stray summing-node capacitance will cause peaking in the frequency response, and large amounts can cause instability. If some stray summing-node capacitance is unavoidable, its effects can be compensated for by placing small capacitors across the feedback resistors.

Terminating a Single-Ended Input

Controlled impedance interconnections are used in most high speed signal applications, and they require at least one line termination. In analog applications, a matched resistive termination is generally placed at the load end of the line. This section deals with how to properly terminate a single-ended input to the AD8137.

The input resistance presented by the AD8137 input circuitry is seen in parallel with the termination resistor, and its loading effect must be taken into account. The Thevenin equivalent circuit of the driver, its source resistance, and the termination resistance must all be included in the calculation as well. An exact solution to the problem requires solution of several simultaneous algebraic equations and is beyond the scope of this data sheet. An iterative solution is also possible and is simpler, especially considering the fact that standard resistor values are generally used.

Figure 66 shows the AD8137 in a unity-gain configuration, and with the following discussion, provides a good example of how to provide a proper termination in a 50 Ω environment.

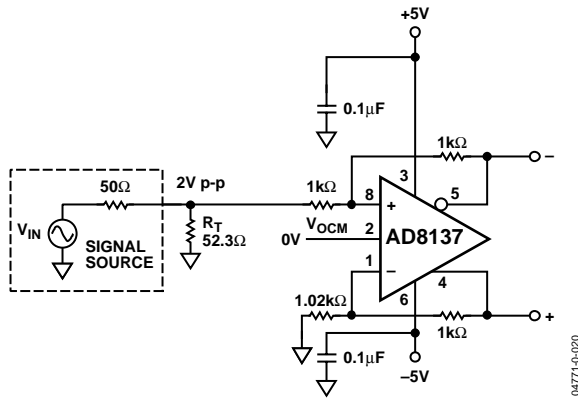


Figure 66. AD8137 with Terminated Input

The 52.3 Ω termination resistor, R_T , in parallel with the 1 kΩ input resistance of the AD8137 circuit, yields an overall input resistance of 50 Ω that is seen by the signal source. In order to have matched feedback loops, each loop must have the same R_G if it has the same R_F . In the input (upper) loop, R_G is equal to the 1 kΩ resistor in series with the (+) input plus the parallel combination of R_T and the source resistance of 50 Ω. In the upper loop, R_G is therefore equal to 1.03 kΩ. The closest standard value is 1.02 kΩ and is used for R_G in the lower loop.

Things become more complicated when it comes to determining the feedback resistor values. The amplitude of the signal source generator V_{IN} is two times the amplitude of its output signal when terminated in 50 Ω. Therefore, a 2 V p-p terminated amplitude is produced by a 4 V p-p amplitude from V_s . The Thevenin equivalent circuit of the signal source and R_T must be used when calculating the closed-loop gain because R_G in the upper loop is split between the 1 kΩ resistor and the Thevenin resistance looking back toward the source. The Thevenin voltage of the signal source is greater than the signal source output voltage when terminated in 50 Ω because R_T must always be greater than 50 Ω. In this case, R_T is 52.3 Ω and the Thevenin voltage and resistance are 2.04 V p-p and 25.6 Ω, respectively.

Now the upper input branch can be viewed as a 2.04 V p-p source in series with 1.03 kΩ. Since this is to be a unity-gain application, a 2 V p-p differential output is required, and R_F must therefore be $1.03 \text{ k}\Omega \times (2/2.04) = 1.01 \text{ k}\Omega \approx 1 \text{ k}\Omega$.

This example shows that when R_F and R_G are large compared to R_T , the gain reduction produced by the increase in R_G is essentially cancelled by the increase in the Thevenin voltage caused by R_T being greater than the output resistance of the signal source. In general, as R_F and R_G become smaller in terminated applications, R_F needs to be increased to compensate for the increase in R_G .

When generating the typical performance characteristics data, the measurements were calibrated to take the effects of the terminations on closed-loop gain into account.

Power Down

The AD8137 features a $\overline{\text{PD}}$ pin that can be used to minimize the quiescent current consumed when the device is not being used. $\overline{\text{PD}}$ is asserted by applying a low logic level to Pin 7. The threshold between high and low logic levels is nominally 1.1 V above the negative supply rail. See the Specification tables (Table 1 to Table 3) for the threshold limits.

DRIVING AN ADC WITH GREATER THAN 12-BIT PERFORMANCE

Since the AD8137 is suitable for 12-bit systems, it is desirable to measure the performance of the amplifier in a system with greater than 12-bit linearity. In particular, the effective number of bits, ENOB, is most interesting. The AD7687, 16-bit, 250 KSPS ADC's performance makes it an ideal candidate for showcasing the 12-bit performance of the AD8137.

For this application, the AD8137 is set in a gain of two and driven single-ended through a 20 kHz band-pass filter, while the output is taken differentially to the input of the AD7687 (see Figure 67). This circuit has mismatched R_G impedances and, therefore, has a dc offset at the differential output. It is included as a test circuit to illustrate the performance of the AD8137. Actual application circuits should have matched feedback networks.

For an AD7687 input range up to -1.82 dBFS , the AD8137 power supply is a single 5 V applied to V_{S+} with V_{S-} tied to ground. To increase the AD7687 input range to -0.45 dBFS , the AD8137 supplies are increased to +6 V and -1 V . In both cases, the V_{OCM} pin is biased with 2.5 V and the $\overline{\text{PD}}$ pin is left floating. All voltage supplies are decoupled with 0.1 µF capacitors. Figure 68 and Figure 69 show the performance of the -1.82 dBFS setup and the -0.45 dBFS setup, respectively.

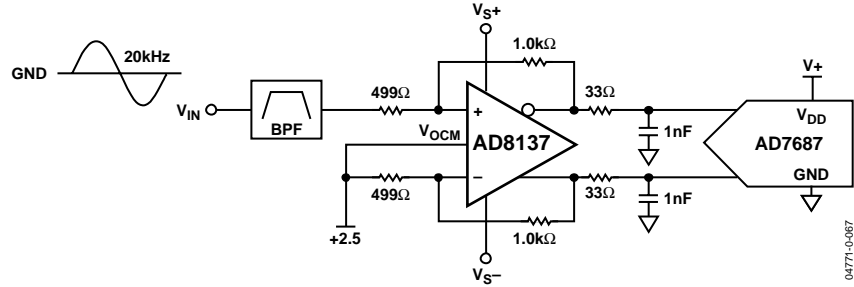


Figure 67. AD8137 Driving AD7687, 16-Bit 250 KSPS ADC

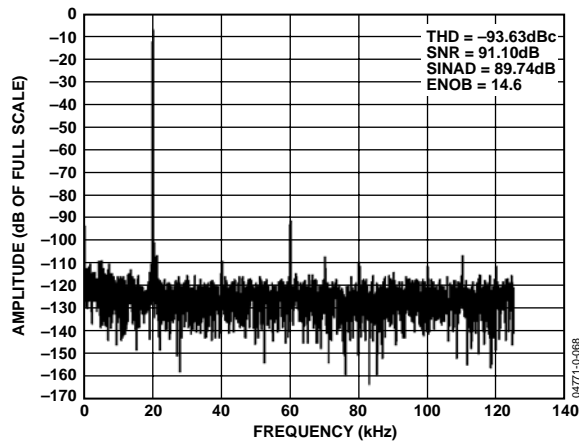


Figure 68. AD8137 Performance on Single 5 V Supply, -1.82 dBFS

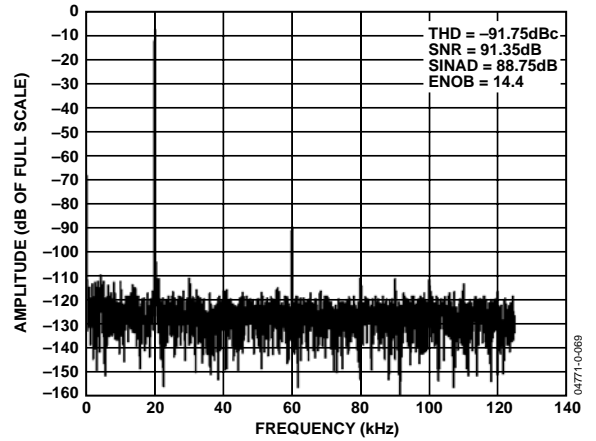
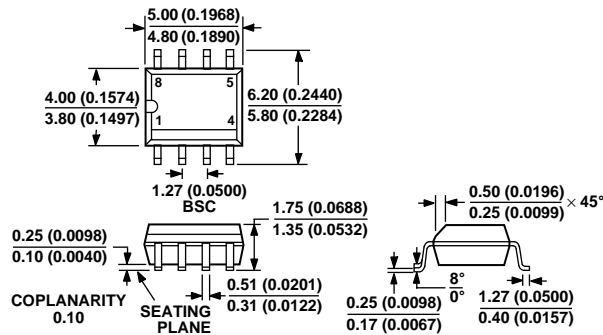


Figure 69. AD8137 Performance on +6 V, -1 V Supplies, -0.45 dBFS

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012-AA
 CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
 (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Figure 70. 8-Lead Standard Small Outline Package [SOIC_N]

Narrow Body
 (R-8)

Dimensions shown in millimeters and (inches)

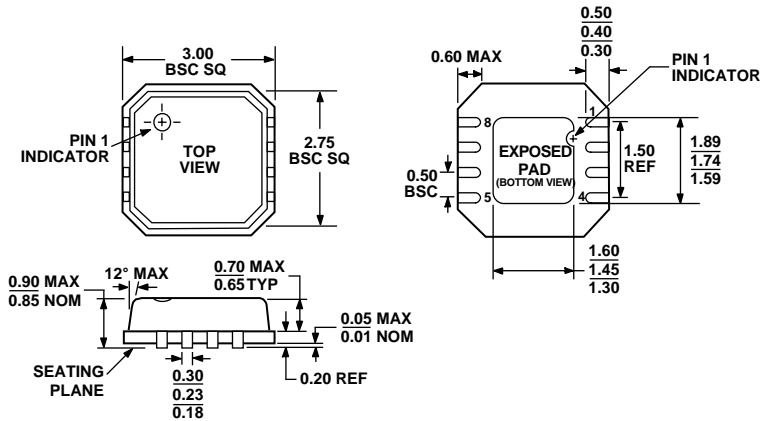


Figure 71. 8-Lead Lead Frame Chip Scale Package [LFCSF_VD]

3 mm x 3 mm Body, Very Thin, Dual Lead
 (CP-8-2)

Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
AD8137YR	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC_N)	R-8	
AD8137YR-REEL	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC_N)	R-8	
AD8137YR-REEL7	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC_N)	R-8	
AD8137YRZ ¹	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC_N)	R-8	
AD8137YRZ-REEL ¹	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC_N)	R-8	
AD8137YRZ-REEL7 ¹	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC_N)	R-8	
AD8137YCP-R2	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSF_VD)	CP-8-2	HFB
AD8137YCP-REEL	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSF_VD)	CP-8-2	HFB
AD8137YCP-REEL7	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSF_VD)	CP-8-2	HFB
AD8137YCPZ-R2 ¹	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSF_VD)	CP-8-2	HFB#
AD8137YCPZ-REEL ¹	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSF_VD)	CP-8-2	HFB#
AD8137YCPZ-REEL7 ¹	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSF_VD)	CP-8-2	HFB#

¹ Z = Pb-free part; # denotes lead-free, may be top or bottom marked.